

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|-------------------|--|-----------------|--------------------|
| Applicant(s) | Wang | Examiner: | Warren, Matthew E. |
| Serial No.: | 10/057,448 | Group Art Unit: | 2815 |
| Confirmation No.: | 1290 | Docket: | 669-77 CON/CIP |
| Filed: | January 25, 2002 | Dated: | March 4, 2005 |
| For: | HIGH DENSITY INTEGRATED CIRCUITS AND THE METHOD OF PACKAGING THE SAME | | |

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

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On: March 4, 2005

By: 

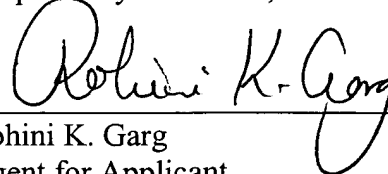
M.J. Mullin

TRANSMITTAL OF FORMAL DRAWINGS

Sir:

Attached please find five (5) sheets of formal drawings for the above-referenced application.

Respectfully submitted,



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